



Series 351000 SSOP-to-DIP Adapter

FEATURES

- Allows the use of 0.65mm pitch surface-mount ICs in thru-hole designs.
- Ideal for prototyping and testing/evaluating SSOP ICs.
- Adapter can be cut to smaller sizes by end user.
- Consult factory for Panelized Form or for mounting of consigned ICs.

GENERAL SPECIFICATIONS

- ADAPTER BODY: FR-4, 0.062 [1.58] thick, with 1-oz. Cu traces
- PINS: Brass 360 1/2-hard per UNS C36000, ASTM B16/B16M
- PIN PLATING: 200 μ [5.08 μ] min. Sn/Pb 93/7 per ASTM B579-73 over 100 μ [2.54 μ] Ni per SAE AMS-QQ-N-290 with 10 μ [0.25 μ] min. Au per MIL-G-4524 over 100 μ [2.54 μ] Ni per SAE AMS-QQ-N-290
- CURRENT RATING: 1 amp
- OPERATING TEMPERATURE: 221°F [105°C]

MOUNTING CONSIDERATIONS

- SUGGESTED PCB HOLE SIZE: 0.028 \pm 0.003 [0.71 \pm 0.08] dia.
- Will plug into standard IC socket

ALL DIMENSIONS: INCHES [MILLIMETERS]

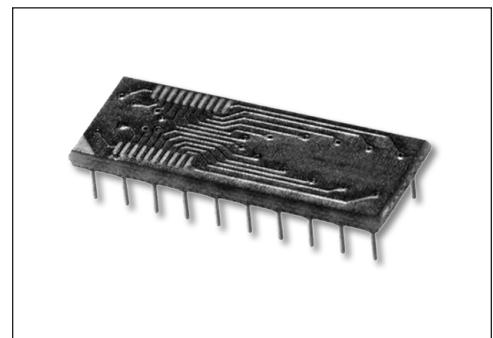
ALL TOLERANCES: \pm 0.005 [0.13] UNLESS OTHERWISE SPECIFIED

"A" # OF PINS PER ROW x 0.100 [2.54]

"B" (# OF PINS PER ROW -1) x 0.100 [2.54]

"C" (# OF PADS PER ROW -1) x 0.0256 [0.65]

CONSULT FACTORY FOR OTHER SIZES AND CONFIGURATIONS



CUSTOMIZATION: In addition to the standard products shown on this page, Aries specializes in custom design and production. Special materials, platings, sizes, and configurations can be furnished, depending on the quantity. **NOTE:** Aries reserves the right to change product general specifications without notice.

ORDERING INFORMATION

XX-351000-10

No. of Pins	14, 16, 18, 20, 24, 28	Plating
Series		10 = Sn/Pb 11 = Au

